

SEMICONDUCTOR®

December 2013

# FQP6N40C

## N-Channel QFET<sup>®</sup> MOSFET

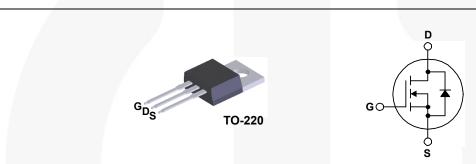
400 V, 6.0 A, 1.0 Ω

### Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

#### Features

- 6.0 A, 400 V,  $R_{DS(on)}$  = 1.0  $\Omega$  (Max.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 3 A
- Low Gate Charge (Typ. 16 nC)
- Low Crss (Typ. 15 pF)
- 100% Avalanche Tested



#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

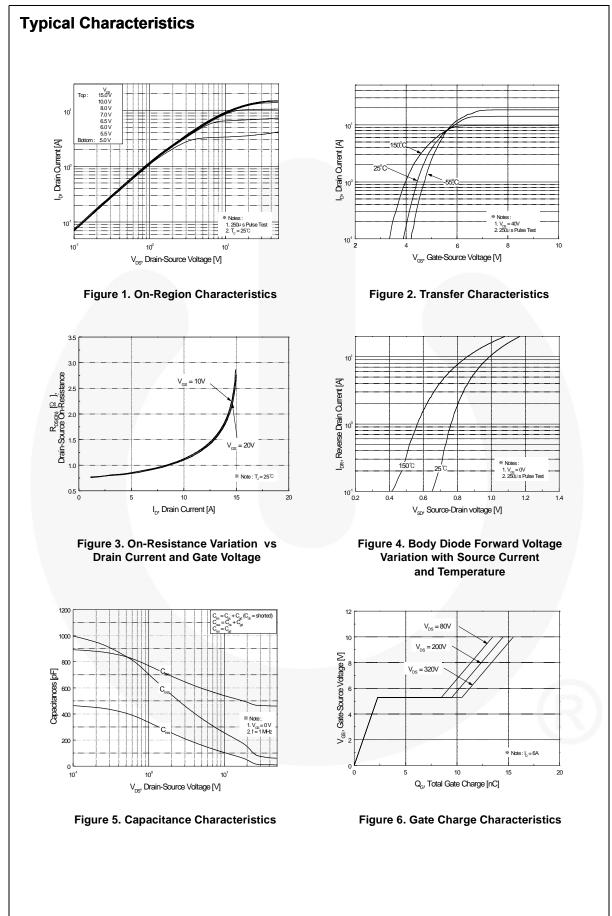
| Symbol                            | Parameter  | FQP6N40C | Unit        |      |  |
|-----------------------------------|--|----------|-------------|------|--|
| V <sub>DSS</sub>                  | Drain-Source Voltage   |          | 400         | V    |  |
| I <sub>D</sub>                    | Drain Current - Continuous ( $T_C = 25^{\circ}C$ )                       |          | 6           | А    |  |
|                                   | - Continuous (T <sub>C</sub> = 100°C)                                    |          | 3.6         | A    |  |
| I <sub>DM</sub>                   | Drain Current - Pulsed   | (Note 1) | 24          | A    |  |
| V <sub>GSS</sub>                  | Gate-Source Voltage  |          | ± 30        | V    |  |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy   | (Note 2) | 270         | mJ   |  |
| I <sub>AR</sub>                   | Avalanche Current  | (Note 1) | 6           | A    |  |
| E <sub>AR</sub>                   | Repetitive Avalanche Energy  | (Note 1) | 7.3         | mJ   |  |
| dv/dt                             | Peak Diode Recovery dv/dt  | (Note 3) | 4.5         | V/ns |  |
| P <sub>D</sub>                    | Power Dissipation ( $T_C = 25^{\circ}C$ )                                |          | 73          | W    |  |
|                                   | - Derate above 25°C  |          | 0.58        | W/°C |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                                  |          | -55 to +150 | °C   |  |
| TL                                | Maximum Lead Temperature for Soldering,<br>1/8" from Case for 5 Seconds. |          | 300         | °C   |  |

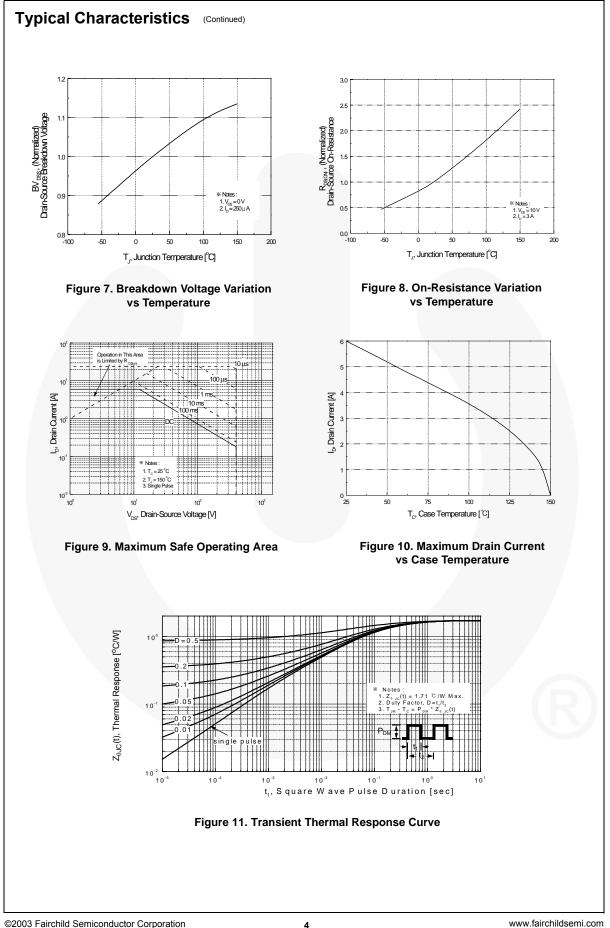
#### **Thermal Characteristics**

| Symbol           | Parameter                                     | FQP6N40C | Unit |  |
|------------------|---|----------|------|--|
| R <sub>θJC</sub> | Thermal Resistance, Junction-to-Case, Max.    | 1.71     | °C/W |  |
| $R_{\thetaJA}$   | Thermal Resistance, Junction-to-Ambient, Max. | 62.5     | °C/W |  |

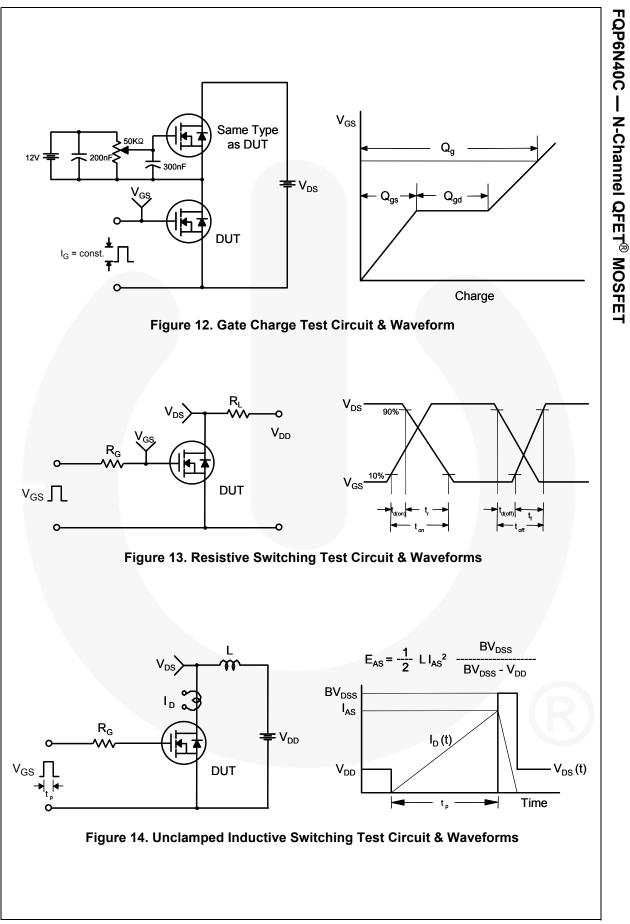
| Part Number<br>FQP6N40C                |  | Top Mark Pac   |                                       | kage Packing Method Reel                                      |  | Size     | Tape Width |      | Quantity |          |
|--|--|--|---------------------------------------|---|--|----------|------------|------|----------|----------|
|  |  | FQP6N40C   | TO-                                   | 220 Tube  |  | N/A      |            | N/A  |          | 50 units |
| lectrio                                | cal Cha                                      | racteristics   | To = 25°0                             | Cunless off   | nerwise noted.                                     |          |            |      |          |          |
| Symbol                                 |  | Parameter  | 6                                     |   | Test Conditions                                    |          | Min.       | Тур. | Max.     | Unit     |
| Off Cha                                | aracterist                                   | ice  |                                       |   |  |          |            |      | ,        | ,        |
| BV <sub>DSS</sub>                      | Drain-Source Breakdown Voltage               |  | V <sub>GS</sub> =                     | 0 V, I <sub>D</sub> = 250 μA                                  |  | 400      |            |      | V        |          |
| ΔBV <sub>DSS</sub><br>/ΔT <sub>J</sub> | Breakdown Voltage Temperature<br>Coefficient |  | $I_D = 250 \mu$ A, Referenced to 25°C |   |  |          | 0.54       |      | V/°C     |          |
| DSS                                    | Zero Gate Voltage Drain Current              |  | ont                                   | V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V                |  |          |            |      | 1        | μA       |
|  |  | -  |                                       | $V_{DS} = 320 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$ |  |          |            |      | 10       | μΑ       |
| I <sub>GSSF</sub>                      | Gate-Body Leakage Current, Forward           |  |                                       | 30 V, V <sub>DS</sub> = 0 V                                   |  |          |            | 100  | nA       |          |
| I <sub>GSSR</sub>                      | Gate-Bod                                     | Gate-Body Leakage Current, Reverse   |                                       | $V_{GS} =$  | -30 V, $V_{DS} = 0 V$                              |          |            |      | -100     | nA       |
| On Cha                                 | aracterist                                   | ics  |                                       |   |  |          |            |      |          |          |
| V <sub>GS(th)</sub>                    | Gate Thre                                    | eshold Voltage   |                                       | $V_{DS} =$  | V <sub>GS</sub> , I <sub>D</sub> = 250 μA          | - /      | 2.0        |      | 4.0      | V        |
| R <sub>DS(on)</sub>                    | Static Dra<br>On-Resist                      | in-Source<br>tance   |                                       | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3A                   |  |          |            | 0.83 | 1        | Ω        |
| 9fs                                    | Forward 7                                    | Transconductance   |                                       | $V_{DS} =$  | 40 V, I <sub>D</sub> = 3A                          |          |            | 4.7  |          | S        |
| Dvnami                                 | ic Chara                                     | cteristics   |                                       |   |  |          |            |      |          |          |
| C <sub>iss</sub>                       | Input Cap                                    |  | _                                     | Vpg =   | 25 V, V <sub>GS</sub> = 0 V,                       |          |            | 480  | 625      | pF       |
| C <sub>oss</sub>                       | Output Ca                                    | apacitance   |                                       | f = 1.0   |  |          |            | 80   | 105      | pF       |
| C <sub>rss</sub>                       | Reverse                                      | Reverse Transfer Capacitance   |                                       |   |  |          |            | 15   | 20       | pF       |
| Switchi                                | ing Char                                     |  |                                       |   |  |          |            |      |          |          |
| t <sub>d(on)</sub>                     |  | acteristics<br>Delay Time  | -                                     |   |  |          |            | 13   | 35       | ns       |
| t <sub>r</sub>                         | Turn-On F                                    |  | _                                     |   | 00 V, $I_D = 6A$ ,                                 |          |            | 65   | 140      | ns       |
| d(off)                                 |  | Delay Time   | _                                     | R <sub>G</sub> = 2  | 5 Ω  |          |            | 21   | 55       | ns       |
| f                                      | Turn-Off F                                   |  |                                       | -   |  | (Note 4) |            | 38   | 85       | ns       |
| Q <sub>g</sub>                         | Total Gate                                   | e Charge   |                                       | Vpc =   | 320 V, I <sub>D</sub> = 6A,                        |          |            | 16   | 20       | nC       |
| Q <sub>gs</sub>                        |  | rce Charge   |                                       | $V_{GS} =$  |  |          |            | 2.3  |          | nC       |
| Q <sub>gd</sub>                        | Gate-Drai                                    | ů,   |                                       | . 62  |  | (Note 4) |            | 8.2  |          | nC       |
| Ducin O                                |  |  |                                       |   |  |          |            |      |          |          |
| Drain-S                                | 1  | ode Character  |                                       |   | •  | - /      |            |      | 6        | A        |
| SM                                     |  | aximum Pulsed Drain-Source Diode F   |                                       |   |  |          |            |      | 24       | A        |
| V <sub>SD</sub>                        |  | Source Diode Forward Voltage   |                                       | $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 6 \text{ A}$           |  |          |            |      | 1.4      | V        |
| t <sub>rr</sub>                        |  | Recovery Time  |                                       |   | $0 \text{ V}, \text{ I}_{\text{S}} = 6 \text{ A},$ |          |            | 230  |          | ns       |
| Q <sub>rr</sub>                        |  | Recovery Charge  |                                       | $dI_{\rm F} / dt = 100 \text{ A/}\mu\text{s}$                 |  |          | 1.7        |      | μC       |          |
|  |  |  |                                       |   |  |          | 1          |      |          | Ŕ        |
|  |  | dth limited by maximum ju<br><sub>DD</sub> = 50 V, R <sub>G</sub> = 25 Ω, star | ting T <sub>J</sub> = 25°             |   |  |          |            |      |          |          |

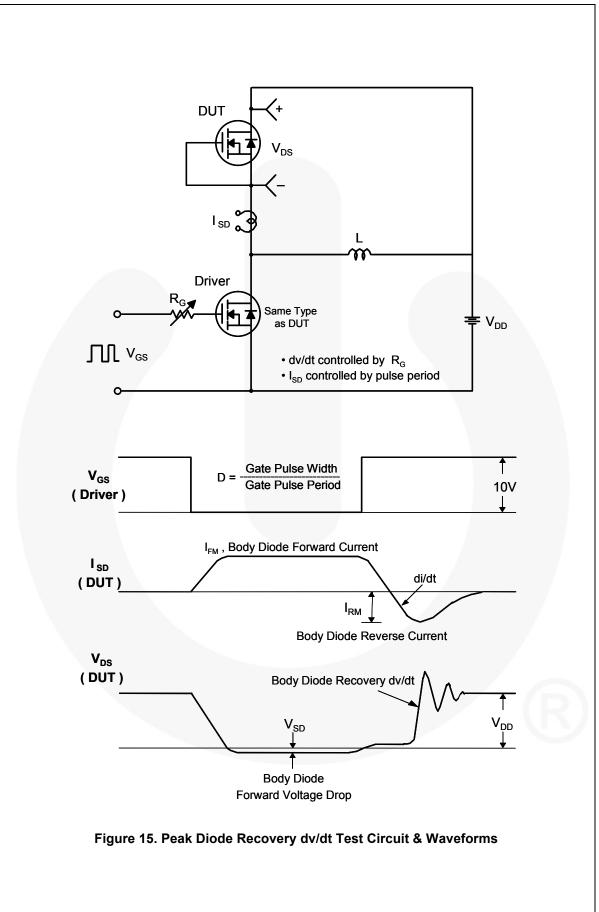
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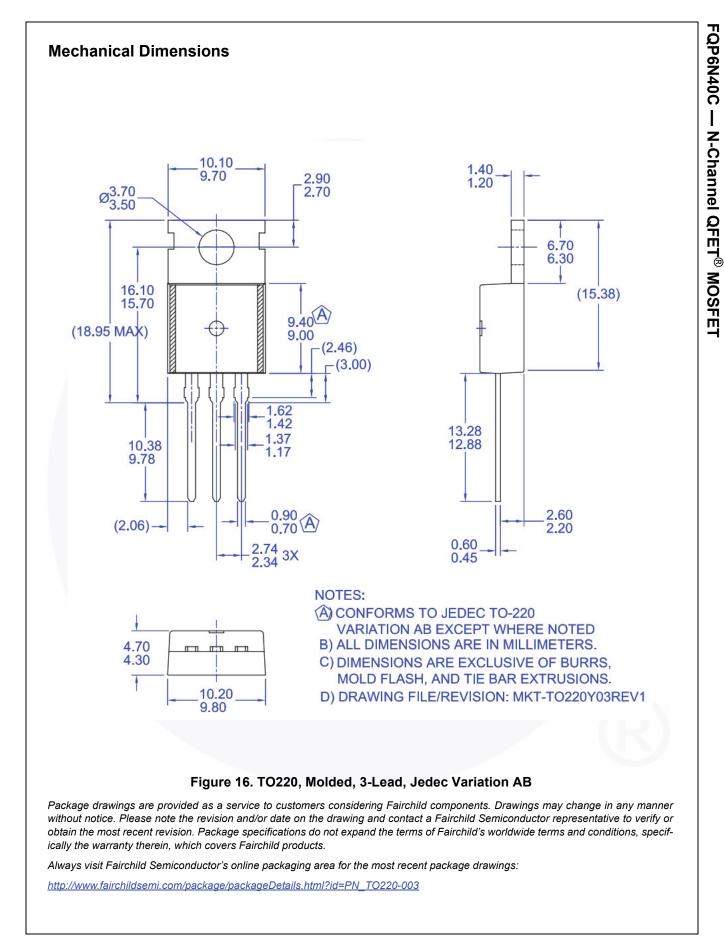




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